

Data Sheet

Description

The ASMT-Bx20 is an environmental friendly green product of unique PCB based subminiature lamps, namely PCB PolyLED. These PolyLEDs come in un-tinted, non-diffused package to cater for various product themes and ease handling applications.

The small size, narrow footprint, and high brightness make these LEDs excellent for backlighting, status indication, and panel illumination applications.

The available colors are AlInGaP Red, AlInGaP Green, InGaN Blue, and AlInGaP Amber.

In order to facilitate pick and place operation, these PCB PolyLEDs are shipped in tape and reel, with 1500 units per reel. The package is compatible with reflow soldering and binned by both color and intensity.

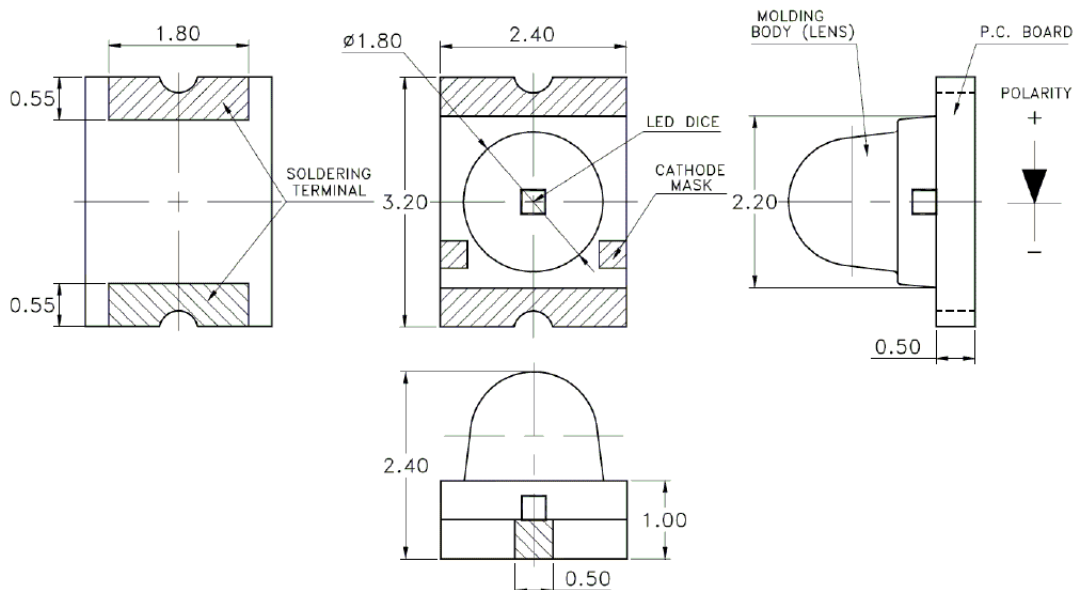
Features

- Small foot print
- Available in four colors
- Low power consumption
- Non-diffused dome for high brightness
- Supreme product quality and reliability
- Operating temperature range of -40 °C to +85°C
- Package in 8mm tape on 7" diameter reels
- Compatible with automated placement equipment
- Compatible with infrared and vapor phase reflow soldering process

Applications

- Panel indicator
- LCD backlighting
- Symbol backlighting
- Push-button backlighting
- Indoor mono/full color sign

Package Dimensions



Notes:

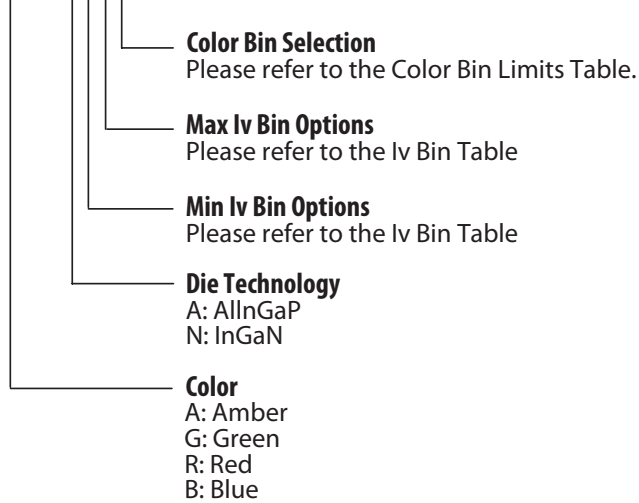
1. All dimensions in millimeters.
2. Tolerance is ± 0.1 mm unless otherwise specified.

Device Selection Guide

Part Number	Die Technology	Color	Package Description
ASMT-BA20	AlInGaP	Amber	Untinted, Non-diffused
ASMT-BG20	AlInGaP	Green	Untinted, Non-diffused
ASMT-BR20	AlInGaP	Red	Untinted, Non-diffused
ASMT-BB20	InGaN	Blue	Untinted, Non-diffused

Part Numbering System

ASMT - B x 20 - x x x x 0



Absolute Maximum Ratings at $T_A = 25^\circ\text{C}$

Parameter	AlInGaP	InGaN	Units
DC Forward Current ^[1]	30	20	mA
Reverse Voltage ($I_R = 100\text{mA}$)	5	5	V
LED Junction Temperature	95	95	$^\circ\text{C}$
Operating Temperature Range	-40 to +85		$^\circ\text{C}$
Storage Temperature Range	-40 to +85		$^\circ\text{C}$
Soldering Temperature (Pb Free)	260 $^\circ\text{C}$ for 10 seconds		

Electrical Characteristics at $T_A = 25^\circ\text{C}$

Part Number	Forward Voltage V_F (Volts) ^[1] @ $I_F = 20\text{mA}$		Reverse Breakdown V_R (Volts) @ $I_R = 100\mu\text{A}$	Thermal Resistance $R_{\theta J-PIN}$ ($^\circ\text{C/W}$)
	Typ.	Max.	Min.	Typ.
AlInGaP Amber	2.0	2.4	5	450
AlInGaP Green	2.0	2.4	5	450
AlInGaP Red	2.0	2.4	5	450
InGaN Blue	3.2	3.8	5	450

Notes:

1. V_F tolerance : $\pm 0.1\text{V}$

Optical Characteristics at T_A = 25°C

Part Number	Luminous Intensity I _V ^[1] (mcd) @ 20mA Typ.	Peak Wavelength λ _{peak} (nm) Typ.	Dominant Wavelength λ _d ^[2] (nm) Typ.	Viewing Angle 2θ _{1/2} ^[3] (Degrees) Typ.
AllInGaP Amber	750	592	590	15
AllInGaP Green	650	565	569	15
AllInGaP Red	650	635	626	15
InGaN Blue	650	470	468	15

Notes:

1. The luminous intensity I_V is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the LED package.
2. The dominant wavelength, λ_d, is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
3. θ_{1/2} is the off-axis angle where the luminous intensity is ½ the peak intensity.

Light Intensity (I_V) Bin Limits^[1]

Bin ID	Intensity (mcd)	
	Minimum	Maximum
P	45.00	71.50
Q	71.50	112.50
R	112.50	180.00
S	180.00	285.00
T	285.00	450.00
U	450.00	715.00
V	715.00	1125.00
W	1125.00	1800.00
X	1800.00	2850.00
Y	2850.00	4500.00

Tolerance : ±15%

Color Bin Limits^[1]

Amber Color Bins^[1]

Bin ID	Dominant Wavelength (nm)	
	Minimum	Maximum
1	582.0	584.5
2	584.5	587.0
3	587.0	589.5
4	589.5	592.0
5	592.0	594.5
6	594.5	597.0

Tolerance : ±1 nm

Green Color Bins^[1]

Bin ID	Dominant Wavelength (nm)	
	Minimum	Maximum
1	561.5	564.5
2	564.5	567.5
3	567.5	570.5
4	570.5	573.5
5	573.5	576.5

Tolerance : ±1 nm

Red Color Bins^[1]

Bin ID	Dominant Wavelength (nm)	
	Minimum	Maximum
-	620.0	635.0

Tolerance : ±1 nm

Blue Color Bins^[1]

Bin ID	Dominant Wavelength (nm)	
	Minimum	Maximum
1	460.0	465.0
2	465.0	470.0
3	470.0	475.0
4	475.0	480.0

Tolerance : ±1 nm

Notes:

1. Bin categories are established for classification of products. Products may not be available in all categories. Please contact your Avago representative for information on current available bins.

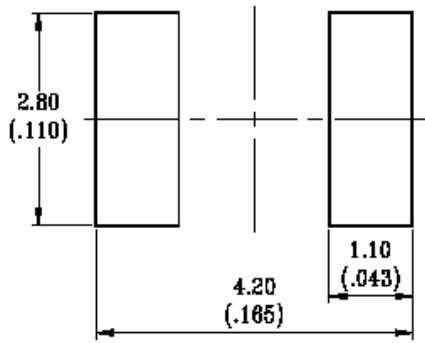


Figure 3. Recommended soldering land pattern.

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.1\text{mm}$ ($\pm 0.004\text{in.}$) unless otherwise specified.

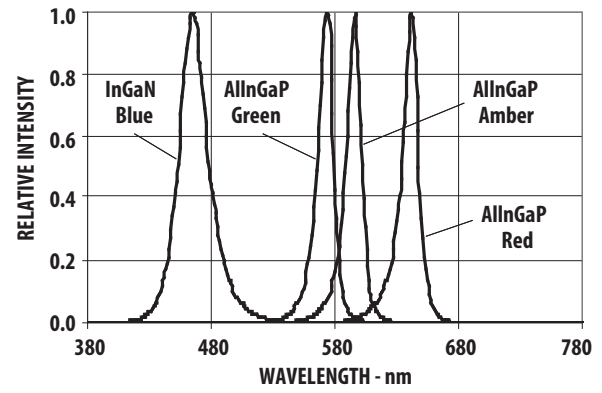


Figure 4. Relative intensity vs. wavelength

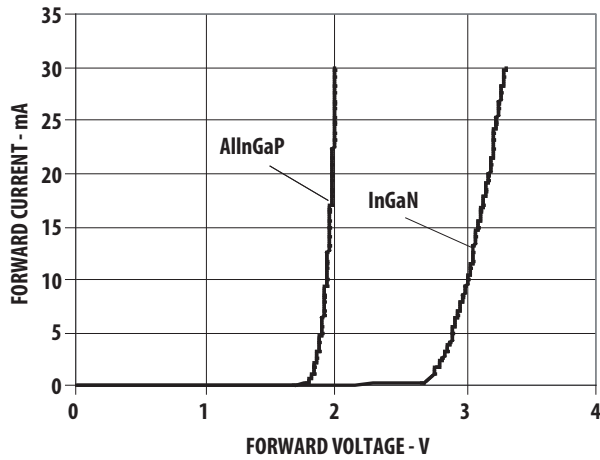


Figure 5. Forward current vs. forward voltage

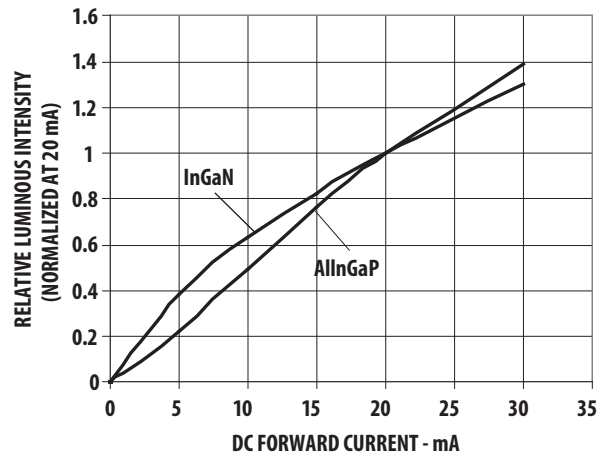


Figure 6. Relative luminous intensity vs. DC forward current

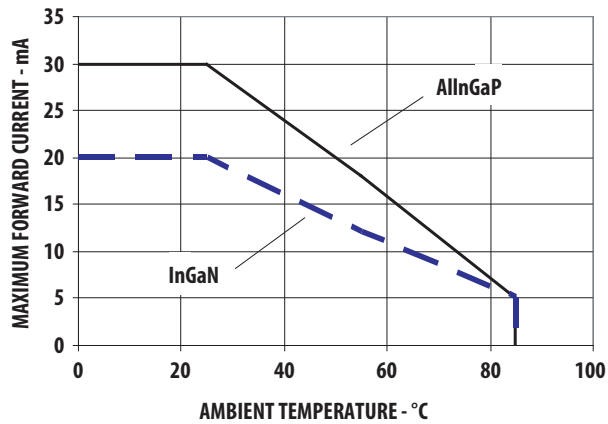


Figure 7. Maximum forward current vs. ambient temperature
For AlInGaP & InGaP Derating based on $T_{JMAX} = 95^{\circ}$

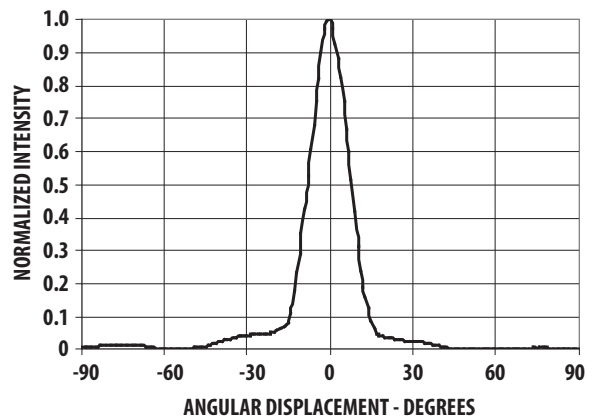


Figure 8. Radiation Pattern

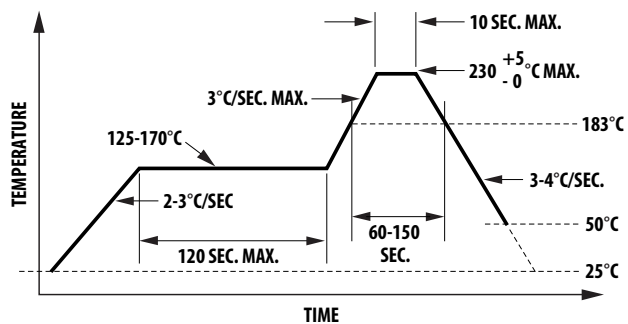


Figure 9. Recommended reflow soldering profile

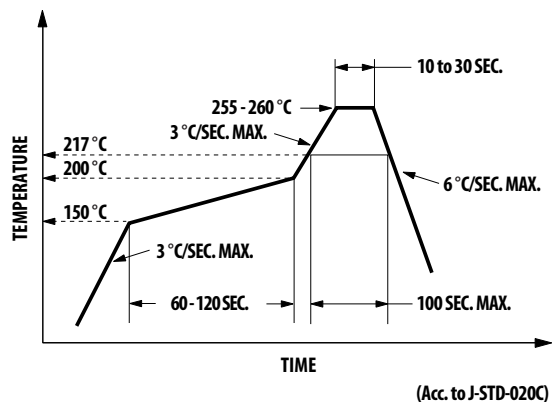


Figure 10. Recommended Pb-free reflow soldering profile

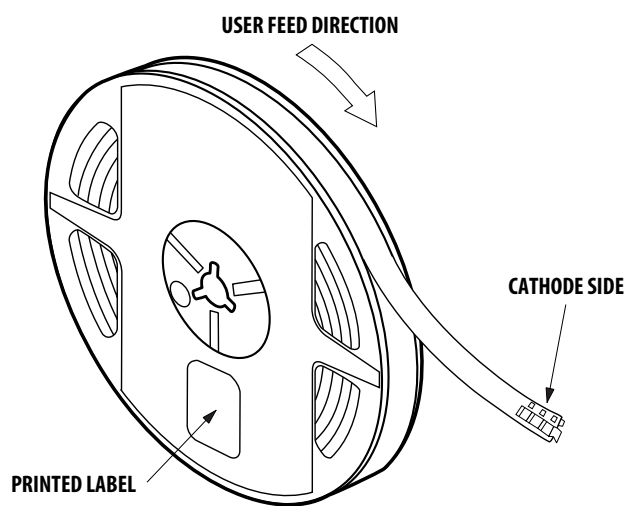


Figure 11. Reeling orientation

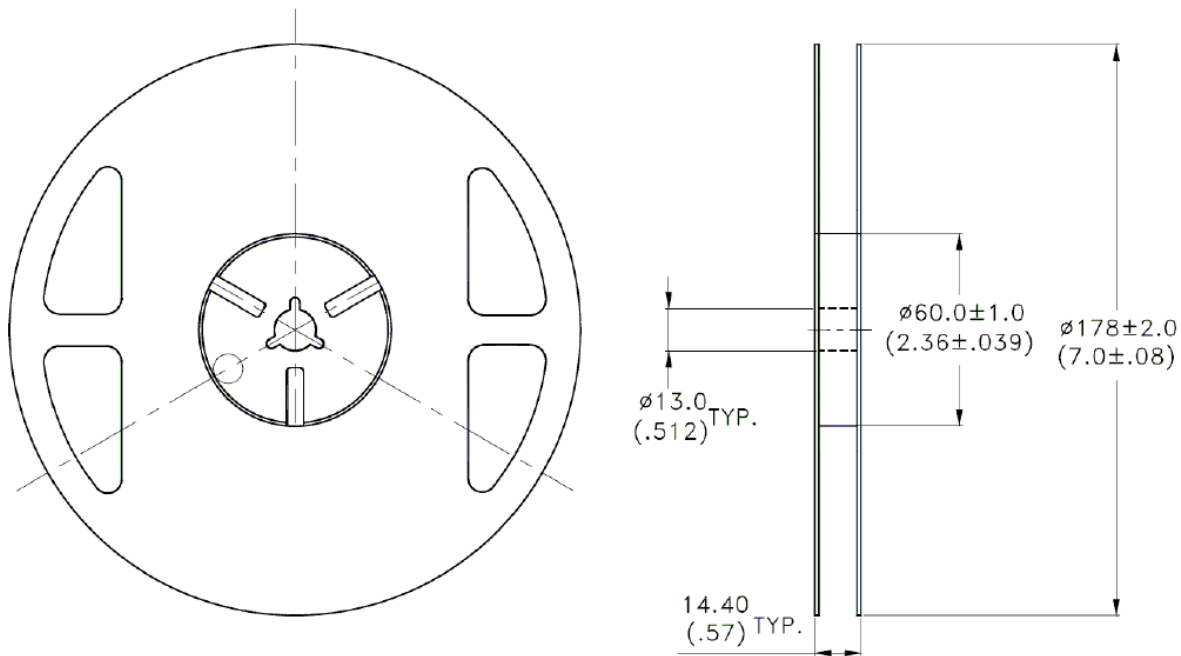


Figure 12. Reel dimensions [1]

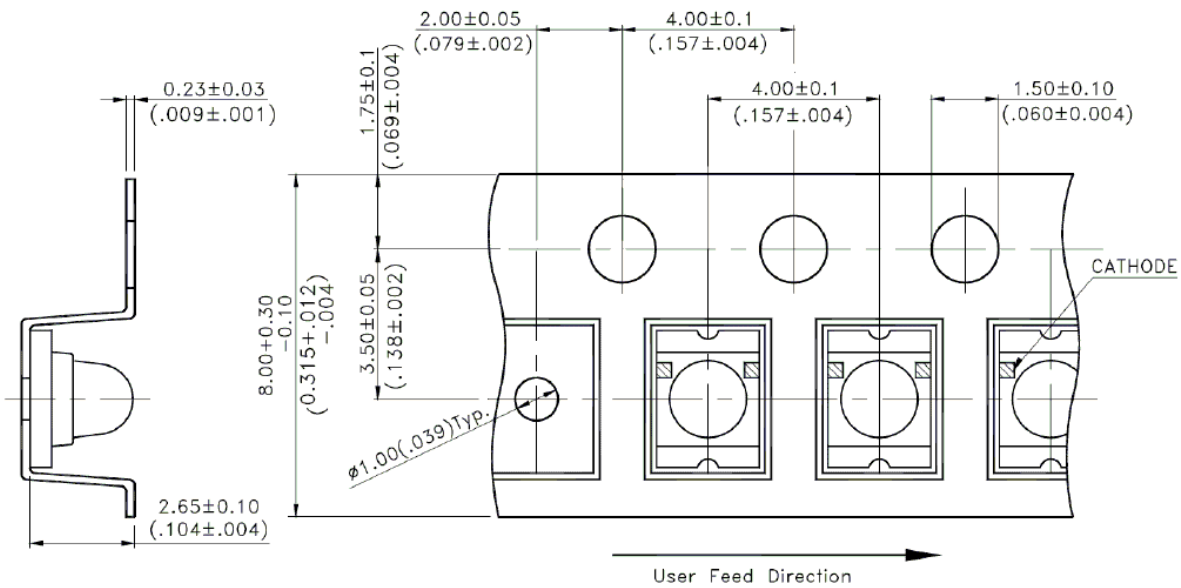


Figure 13. Tape dimensions [1]

Notes:

1. All dimensions are in millimeters (inches).

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AV02-0389EN - August 29, 2008

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